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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





# FDS6898A

# Dual N-Channel Logic Level PWM Optimized PowerTrench<sup>®</sup> MOSFET

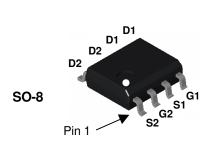
# **General Description**

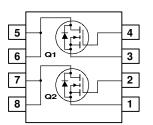
These N-Channel Logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

# Features

- 9.4 A, 20 V  $\begin{array}{c} R_{\text{DS}(\text{ON})} = 14 \ m\Omega \ @ \ \text{V}_{\text{GS}} = 4.5 \ \text{V} \\ R_{\text{DS}(\text{ON})} = 18 \ m\Omega \ @ \ \text{V}_{\text{GS}} = 2.5 \ \text{V} \end{array}$
- Low gate charge (16 nC typical)
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- High power and current handling capability





# Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol	Parameter			Ratings	U	nits	
V <sub>DSS</sub>	Drain-Sour	Drain-Source Voltage			20		V
V <sub>GSS</sub>	Gate-Source Voltage			± 12		V	
ID	Drain Curre	ent – Continuous		(Note 1a)	9.4		А
		– Pulsed			38		
P <sub>D</sub>	Power Dissipation for Dual Operation				2	,	W
	Power Dissipation for Single Operation (Note 1a)			(Note 1a)	1.6		
				(Note 1b)	1		
				(Note 1c)	0.9		
T <sub>J</sub> , T <sub>STG</sub>	Operating a	and Storage Junction T	emperatu	re Range	-55 to +150	c	°C
Therma	l Charac	teristics					
$R_{\theta JA}$	Thermal Re	mal Resistance, Junction-to-Ambient (N		(Note 1a)	78	°C	C/W
$R_{\theta JC}$	Thermal Re	esistance, Junction-to-C	Case	(Note 1)	40	°C	C/W
Packag	e Markin	g and Orderin	g Infor	mation			
Device Marking		Device	Ree	el Size	Tape width	Quanti	ity
FDS6898A		FDS6898A	-	13"	12mm	2500 ur	nits

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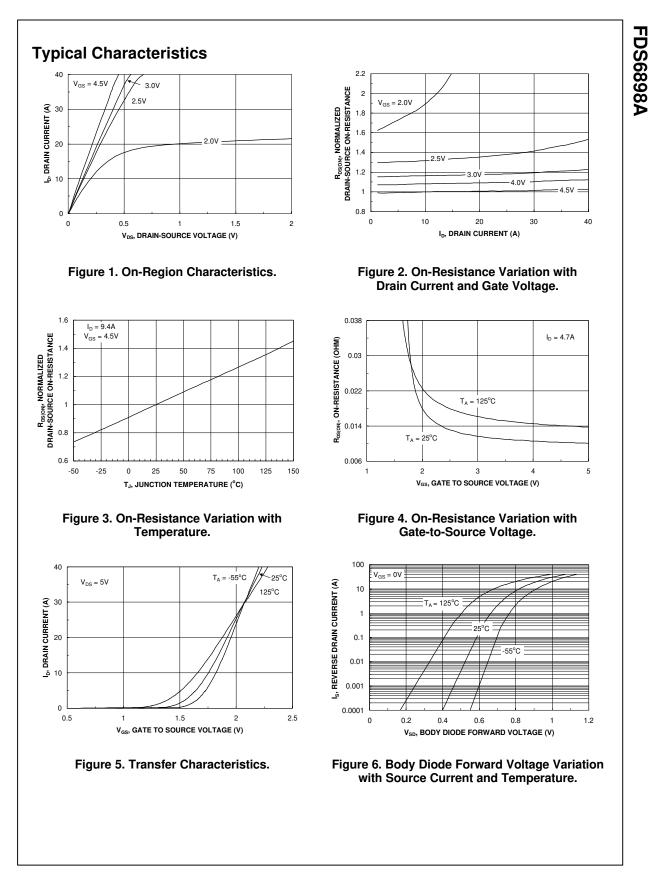
FDS6898A

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		1	1	1	I
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		21		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{\text{GS}} = 12 \ V,  V_{\text{DS}} = 0 \ V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -12 \ V,  V_{DS} = 0 \ V$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.5	1	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		-3.5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, \ I_D = 9.4 \ A \\ V_{GS} = 2.5 \ V, \ I_D = 8.3 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 9.4 \ A, T_J = 125^\circ C \end{array} $		10 13 14	14 18 21	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 4.5V, \qquad V_{DS} = 5 \ V$	19			Α
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{\text{DS}} = 5 \text{ V}, \qquad I_{\text{D}} = 9.4 \text{ A}$		47		S
Dynamic	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ ,		1821		pF
Coss	Output Capacitance	f = 1.0 MHz		440		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			208		pF
Switchir	ng Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{\text{DD}} = 10 \text{ V}, \qquad I_{\text{D}} = 1 \text{ A},$		10	20	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V},  R_{GEN} = 6 \Omega$		15	27	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			34	55	ns
t <sub>f</sub>	Turn–Off Fall Time			16	29	ns
Qg	Total Gate Charge	$V_{DS} = 10 V$ , $I_{D} = 9.4 A$ ,		16	23	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 4.5 V$		3		nC
Q <sub>gd</sub>	Gate-Drain Charge			4		nC
Drain-S	ource Diode Characteristics a	and Maximum Ratings				
ls	Maximum Continuous Drain-Source	Diode Forward Current			1.3	Α
	Drain–Source Diode Forward	$V_{GS} = 0 V, I_{S} = 1.3 A$ (Note 2)		0.7	1.2	V

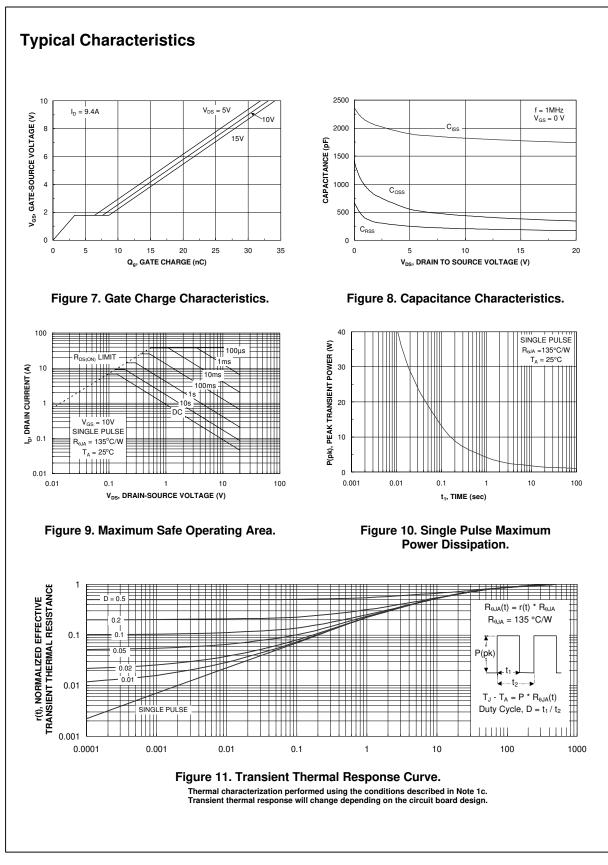
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied



FDS6898A Rev C (W)



FDS6898A Rev C (W)

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Product Status	Definition			
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Rev. H4